

What is Claimed is:

1. An improved LED package, comprising:
a first stand, having a concave bowl section thereon and a first pin extended
5 from the bottom thereof;
a second stand, being adjacent to but a distance apart from said first stand,
and having a second pin disposed at the bottom of said second stand;
an LED chip, being disposed in said bowl section, and using a conductive
metal wire to electrically couple to said second stand; and
10 a packaging object, for encapsulating said first stand, second stand, and LED
chip, and exposing only said first pin and second pin, and having a plane
perpendicular to the light traveling direction and disposed at a top surface of
said packaging object, and said top surface comprising at least a circular
protrusion.
- 15 2. The improved LED package of claim 1, wherein said first bowl section
disposed on said first stand has an elliptic cross section.
3. The improved LED package of claim 1, wherein said conductive metal
wire has one end coupled to the anode of said LED chip.
4. The improved LED package of claim 1, wherein said packaging object
20 is epoxy.